

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SUNG-WAN PYO	08/24/2017
OUN-GYU LEE	08/24/2017
YOUNG-HWAN PARK	08/24/2017
RECEIVING PARTY DATA	
Name:	SFC CO., LTD.
Street Address:	89, GWAHAKSANEOUNP5-RO, OCHANG-EUP, CHEONGWON-GU
Internal Address:	CHUNGCHONGBUK-DO
City:	CHEONGJU-SI
State/Country:	KOREA, REPUBLIC OF
Postal Code:	28122
Name:	SAMSUNG DISPLAY CO., LTD.
Street Address:	1, SAMSUNG-RO, GIHEUNG-GU
Internal Address:	GYEONGGI-DO
City:	YONGIN-SI
State/Country:	KOREA, REPUBLIC OF
Postal Code:	17113
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15687442
CORRESPONDENCE DATA	
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NAME OF SUBMITTER:	MINCHUL YANG
SIGNATURE:	/minchul yang/
DATE SIGNED:	08/26/2017
Total Attachments: 1 source=assn170056#page1.tif	

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by

[Insert ASSIGNEE's
Name(s) Address(es)]

SFC CO., LTD.

**89, Gwahaksaneoup5-ro, Ochang-eup, Cheongwon-gun, Chungcheongbuk-do, Cheongju-si, 28122
Republic of Korea**

Samsung Display Co., Ltd.

**1, Samsung-ro, Giheung-gu, Yongin-si, Gyeonggi-do, 17113
Republic of Korea**

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest, including the right to sue for past infringement, if any, and all rights pursuant to 35 U.S.C. §154, to the invention entitled

[Title of Invention]

**APPARATUS FOR EVALUATION OF DEPOSITION PROCESS IN MANUFACTURING OF
ORGANIC THIN FILM**

[*If the assignment
is being filed
after the filing of the
application, this
section must be
completed]

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

filed on 26-AUG-2017, Serial No. 15687442
(STIP Law Group LLC is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute, reissue or reexamination thereof, and any other application claiming priority thereto, for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with application and any continuing, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, division, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

Sung-Wan PYO
Name


Signature

2017. 8. 24
Date

Oun-Gyu LEE
Name


Signature

2017. 8. 24
Date

Young-Hwan PARK
Name


Signature

2017. 08. 24
Date